Crystal Clear Technology

Product Specification

C420x01 series

Crystal Clear Technology sdn. bhd.

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1.0 Table of Contents

		Page
1.	Contents	1
2.	Record of revision	2
3.	General specification	3
4.	Absolute maximum ratings	4
5.	Electrical characteristics	4
6.	Environmental requirement	4
7.	LCD specification	5 ~ 7
8.	Interfacing	8
9.	Timing characteristics	9 ~ 11
10.	Power supply	12
11.	Block diagram	13
12.	Instructions	14 ~ 16
13.	Quality assurance	17 ~ 18
14.	Precautions in use LCM	$19 \sim 20$
15.	Mechanical drawing	21



2.0 Record of revision

Rev	Date	Item	Page	Comment	Originator	Checked By
1.0	04/06/08			Initial Release	Syam	Azhar
2.0	06/12/10	11	12	Revise Block Diagram	Chong	Azhar



3.0 General specification

Display format: 4 lines x 20 characters

Character font format: 5 x 8

Character size: 2.95mm x 4.75mm

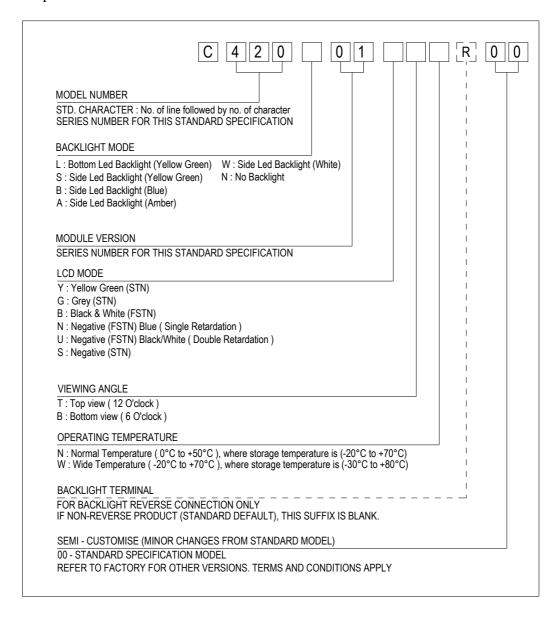
View area: 76.3mm x 25.0mm

Active area: 70.4mm x 20.8mm

General dimensions: 98.0mm x 60.0mm

Controller/Driver: ST7066U-0A-B and ST7063C-B or S6A0066U and S6A2067

or equivalent.



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Spec. No: C420x01xxW00 REV. 1.0

4.0 Absolute maximum rating (at Vss = 0V, ambient temperature = 25°C)

NO	ITEM	SIMBOL	MIN	MAX	UNIT		
1.	Power Supply voltage (Logic)	$V_{\mathrm{DD}} - V_{\mathrm{SS}}$	0	7	V		
2.	Power Supply voltage (LCD Driver)	$V_{DD} - V_0$	-	12	V		
3.	Operating Temperature	T _{op}	Refer p	Refer page 3			
4.	Storage Temperature	T_{st}	Refer p	°C			

5.0 Electrical characteristics

NO	ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
1.	Power Supply voltage (Logic)	$V_{DD} - V_{SS}$	-	3.3*	5.0	5.5	V
2.	Power Supply voltage (V _{LCD})	V_{DD} - V_{0}	25°C	4	V		
3.	Input Voltage	$V_{ m IH}$	-	$0.7V_{DD}$	1	$V_{ m DD}$	V
	(except OSC1)	$V_{ m IL}$	-	-0.3	-	0.6	V
4.	Current Supply	I_{DD}	$V_{DD} - V_{SS} = 5V$	1.0	1.3	2.0	mA

^{*} Note: Customer must supply negative voltage (Vee) to get the correct Vlcd.

5.1 Backlight Options

NO	COLOR	FORWARD VOLTAGE FORWARD CURRED (MA)						MIN BRIGHTNESS
		Min	Тур.	Max	Min	Тур.	Max	(cd/m2) *
1.	Yellow Green	-	5.0	-	-	95	130	100
2.	White	-	5.0	ı	-	40	60	100
3.	Blue	-	5.0	1	-	40	60	6
4.	YG Side	-	5.0	-	-	26	40	6
5.	Amber Side	-	5.0	ı	-	26	40	20

^{*}Note: 1. Brightness measured at backlight surface.

6.0 Environmental requirements

NO	ITEM	CONDITION
1.	Operating	Refer page 3
	Temperature	
2.	Storage Temperature	Refer page 3
3.	Operating Humidity	5% to 95%RH
4.	Cycle Test	-20 °C @ 30 min to 70 °C @ 30min for 1 cycle run for 10 cycles
5.	Lifetime	50000 HOURS (excluding backlight)

Note: The background on LCD has the possibility to be changed in different temperature range.

^{2.} On LCD surface, brightness is only about 10% to 15% of backlight brightness.

^{3.} Lifetime of backlight: For YG, Amber = 50K hrs. For White, Blue = 20K hrs





7.0 LCD specification

7.1 Electro-optical characteristics (at ambient temperature = 25° C)

						LCD '	ГҮРЕ			
NO	ITEM	SYMBOL	CONDITION	STN YG	STN GREY	STN -VE BLUE	FSTN +VE B/W	FSTN -VE BLUE	FSTN -VE TRUE B/W	REF.
1	Operating Voltage (Volt)	V_{LCD}	$\theta = 0$ $Cr = max$			4.5 ±	= 5%			7.1.1
	77.	θ x 1		+25	+20	+35	+25	+35	+35	
2	Viewing Angle (Deg)	θ x 2	$CR \ge 2$	-25	-20	-35	-25	-35	-40	7.1.2
		θу1	$V_{LCD} = 4.5V$	-30	-25	-35	-30	-35	-35	1.1.2
		θу2		+30	+25	+35	+30	+35	+35	
3	Contrast Ratio	CR	$\theta = 0^0$ $V_{LCD} = 4.5V$	3.0	2.3	6.0	3.0	6.0	20	7.1.3
	Response	Rise Time (Tr)	$\theta = 0_0$	200						
4	Time (msec)	Decay Time (Td)	$\theta = 0_0$			25	50			

Note:

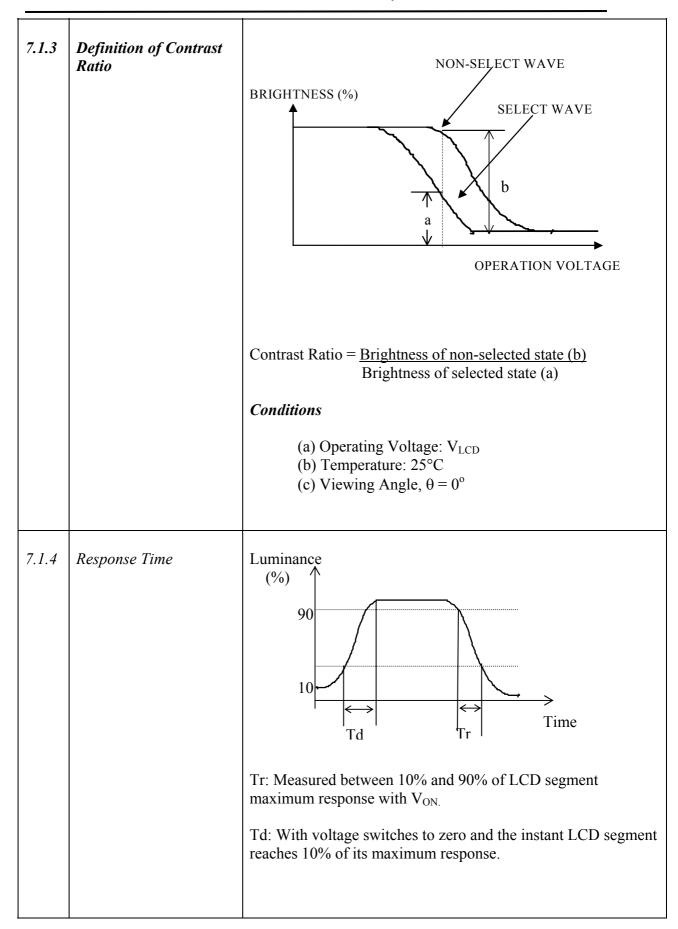
- 1. Viewing angle data is based on bottom view product by default. Should it be a top view product, values are then swap.
- 2. Contrast ratio is based on typical data when using white colour as backlight.
- 3. Equipment Used Eldim; Ez Contrast 120R, Spot Size = 2mm





NO	CHARACTERISTICS	<u>DEFINITIONS</u>
7.1.1	Definition of Operating Voltage (V _{LCD})	V_{LCD} $V_{LCD}: Operating Voltage$ $F: Frame Frequency$
7.1.2	Definition of Viewing Angle	θ REAR RIGHT FRONT BOTTOM
		REAR (θ y2) LEFT(θ x2) RIGHT(θ x1) FRONT (θ y1)









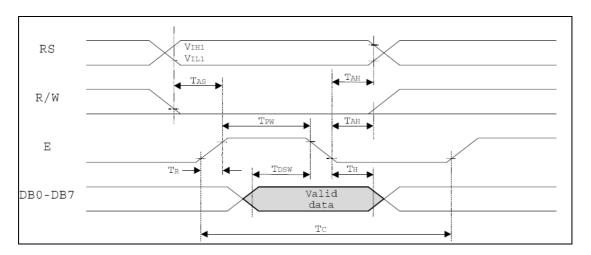
8.0 Interface

8.1	Display Driver	ST7066U ar	nd ST7063C or S6A0066U and S6A2067				
8.2	Duty Cycle	1/16					
8.3	Pin-out Assignment	s					
	Pin No	Symbol	Description				
	1	V _{SS}	Ground terminal of module				
	2	$V_{ m DD}$	Supply terminal of module				
	3	Vo	Power supply for Liquid Crystal Drive				
	4	RS	Register Select: RS = 0 Instruction Register RS = 1 Data Register				
	5	R/W	Read/Write: High = Read Low = Write				
	6	Е	Enable				
	7 to 14	D0 to D7	Bi-directional Data Bus. Data Transfer is performed once, thru D0 to D7, in the case of interface data length is 8-bits.				
	15	(BL -)	LED power supply terminals				
	16	(BL +)	7				

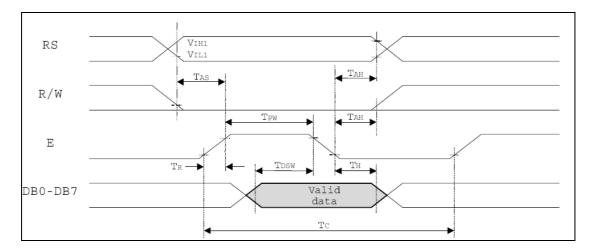




9.0 Timing Characteristics/Timing Diagrams



Write mode

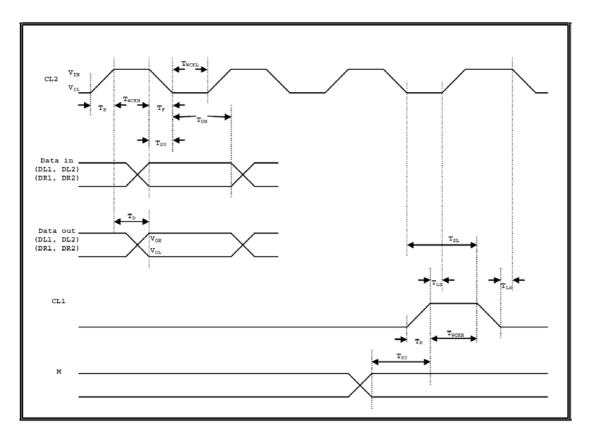


Read mode



Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
		Internal Clock Operation	1	'	•	1
fosc	OSC Frequency	R = 91ΚΩ	190	280	350	KHz
		External Clock Operation	n			
f_{EX}	External Frequency	-	125	280	350	KHz
	Duty Cycle	-	45	50	55	%
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μs
	Write Mo	de (Writing data from MPU	to ST70	066)		1
Tc	Enable Cycle Time	Pin E	1200	-	-	ns
T _{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns
T _{AS}	Address Setup Time	Pins: RS,RW,E	0	-	-	ns
T _{AH}	Address Hold Time	Pins: RS,RW,E	10	-	-	ns
T _{DSW}	Data Setup Time	Pins: DB0 - DB7	40	-	-	ns
T _H	Data Hold Time	Pins: DB0 - DB7	10	-	-	ns
	Read Mod	le (Reading Data from ST7	7066 to N	1PU)	•	
Tc	Enable Cycle Time	Pin E	1200	-	-	ns
T _{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns
T _{AS}	Address Setup Time	Pins: RS,RW,E	0	-	-	ns
T _{AH}	Address Hold Time	Pins: RS,RW,E	10	-	-	ns
T _{DDR}	Data Setup Time	Pins: DB0 - DB7	-	-	100	ns
T _H	Data Hold Time	Pins: DB0 - DB7	10	-	-	ns
	Interf	ace Mode with LCD Driver(ST7065,)	•	•
T _{CWH}	Clock Pulse with High	Pins: CL1, CL2	800	-	-	ns
T _{CWL}	Clock Pulse with Low	Pins: CL1, CL2	800	-	-	ns
T _{CST}	Clock Setup Time	Pins: CL1, CL2	500	-	-	ns
T _{SU}	Data Setup Time	Pin: D	300	-	-	ns
T _{DH}	Data Hold Time	Pin: D	300	-	-	ns
T _{DM}	M Delay Time	Pin: M	-1000	-	1000	ns



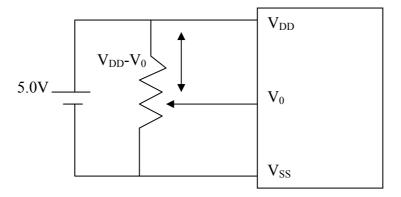


Interface with extension driver

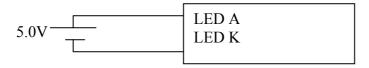
Symbol	Parameter	Test Condition	Min.	Max.	Unit	Applicable pin
FCL	Data Shift Frequency	-	-	400	KHZ	CL2
TWCKH	Clock High Level Width	-	800	-	ns	CL1,CL2
TWCKL	Clock Low Level Width	-	800	-	ns	CL2
TSL	Clock Set-up Time	CL2 → CL1	500	-	ns	CL1,CL2
TLS	Clock Set-up Time	CL1 → CL2	500	-	ns	CL1,CL2
TR/TF	Clock Rise/Fall Time	-	-	200	ns	CL1,CL2
TSU	Data Set-up Time	-	300	-	ns	DL1,DL2,DR1,DR2
TDH	Data Hold Time	-	300	-	ns	DL1,DL2,DR1,DR2
TD	Data Delay Time	CL = 15 PF	-	500	ns	DL1,DL2,DR1,DR2



10.0 Power Supply

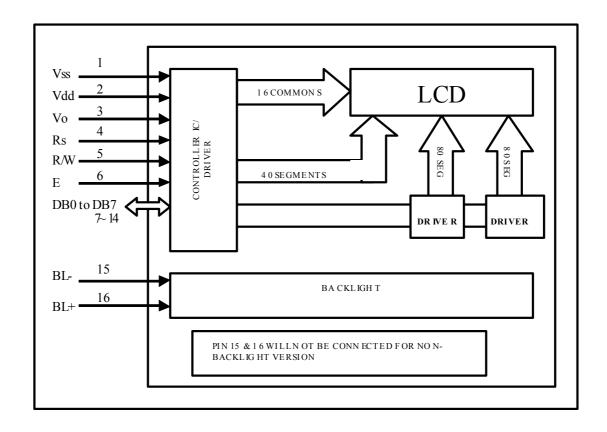


Where V_{DD} - V_0 = LCD Driving voltage



For backlight version only

11.0 Block Diagram





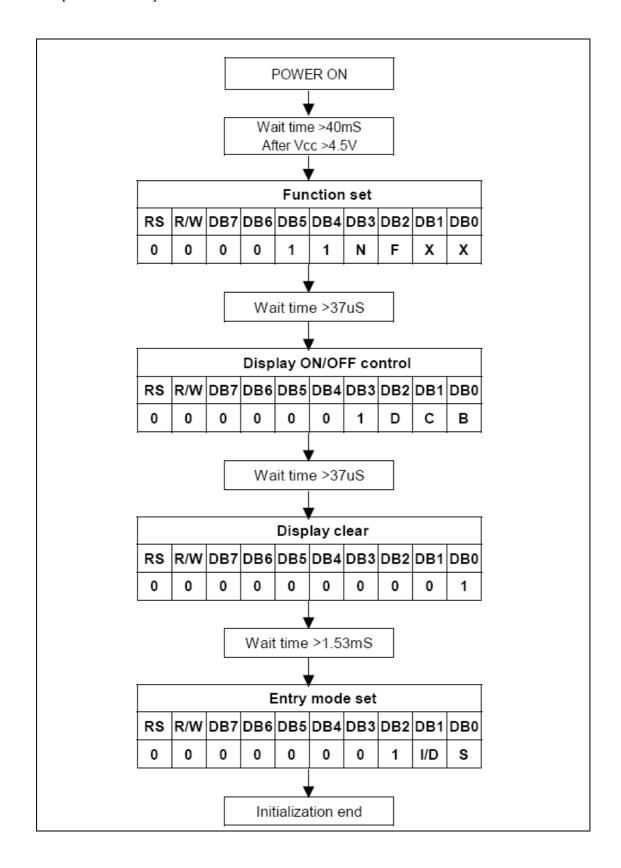


12.0 Instructions

	Instruction Code											Description
Instruction	RS	RW	DB	DB	DB	DB	DB	DB	DB	DB	Description	Time
	KS	KVV	7	6	5	4	3	2	1	0		(270KHZ)
Clear	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set	1.52 ms
Display	U	0	U	"	0	"	"	U	0	'	DDRAM address to "00H" from AC	1.52 1115
											Set DDRAM address to "00H" from AC	
Return	0	0 0	0 0	0	0	0	0	0	1	х	and return cursor to its original position	1.52 ms
Home											if shifted. The contents of DDRAM are	
											not changed.	
											Sets cursor move direction and	
Entry Mode	0	0	0	0	0	0	0	1	I/D	s	specifies display shift. These operations	37 us
Set											are performed during data write and	
											read.	
Display	_			0		_				_	D=1: entire display on	
ON/OFF	0	0	0 0		0	0	1	D	С	В	C=1: cursor on	37 us
											B=1: cursor position on	
Cursor or	_	_	_	_	_						Set cursor moving and display shift	
Display	0	0	0	0	0	1	S/C	R/L	Х	Х	control bit, and the direction, without	37 us
Shift											changing DDRAM data.	
Function							١	F			DL: interface data is 8/4 bits	07
Set	0	0 0	0 0	0 0	1	1 DL	N	Г	х	х	NL: number of line is 2/1	37 us
0-4											F: font size is 5x11/5x8	
Set				١.	AC	AC	AC	AC	AC	AC	Set CGRAM address in address counter	0.7
CGRAM	0	0	0	1	5	4	3	2	1	0		37 us
address Set DDRAM				AC	AC	AC	AC	AC	AC	AC	Set DDRAM address in address counter	
address	0	0	1	6	5 5	4	3	2	1	0	Set DDRAM address in address counter	37 us
auuress				0	5	4	3		'	U	Whether during internal operation or not	
Read Busy				AC	AC	AC	AC	AC	AC	AC	can be known by reading BF. The	
flag and	0	1	BF	6	5	4	3	2	1	0	contents of address counter can also be	0 us
address				ľ	0	-	ľ	_	'	Ü	read.	
Write data											Write data into internal RAM	
to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	(DDRAM/CGRAM)	37 us
Read data											Read data from internal RAM	
from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	(DDRAM/CGRAM)	37 us



8 bit operation example.





Relationship between character code (DDRAM) and character pattern (CGRAM)

Character Code						CGRAM				Character Patterns														
(DDRAM Data)					Address				(CGRAM Data)															
b7	b6	b5	b4	b3	b3	b1	b0	b5	b4	b3	b2	b1	b0	b7	b6	b5	b4	b3	b2	b1	b0			
					0	0	0				0	0	0				1	1	1	1	1			
					0	0	0				0	0	1				0	0	1	0	0			
			0		0	0	0		0	0	0	1	0				0	0	1	0	0			
0	0	0			0	0	0	0			0	1	1			-	0	0	1	0	0			
U		U		_	0	0	0				1	0	0	_	_		0	0	1	0	0			
					0	0	0				1	0	1				0	0	1	0	0			
						0	0	0 0			1	1	0	Ī			0	0	1	0	0			
					0	0	0				1	1	1				0	0	0	0	0			
					0	0	1	1			0	0	0				1	1	1	1	0			
					0	0	1				0	0	1		-		1	0	0	0	1			
					0	0	1				0	1	0			-	1	0	0	0	1			
0	0	0			0	0	1	0		_	0	1	1	Ī			1	1	1	1	0			
U		0	0	- '	0	0	1	U	0	0	1	0	0	-			1	0	1	0	0			
								0	0	1				1	0	1				1	0	0	1	0
					0	0	1				1	1	0				1	0	0	0	1			
					0	0	1				1	1	1	Ī			0	0	0	0	0			



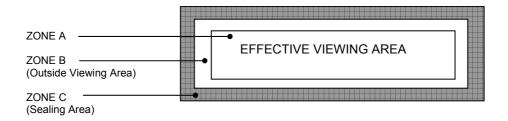


Character Generator ROM (ST7066U-0A-B)

67-64 63-60	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)															
0001	(2)															
0010	(3)															
0011	(4)															
0100	(5)															
0101	(6)															
0110	(7)															
0111	(8)															
1000	(1)															
1001	(2)															
1010	(3)															
1011	(4)															
1100	(5)															
1101	(6)															
1110	(7)															
1111	(8)															

13.0 Quality Assurance

13.1 ZONE DEFINITION



13.1.1 Black Spot, White Spot and Foreign Material

Defect Category	Defect Description	Crite	Drawing Specification			
Black Spot, White Spot	Black Spot, White Spot and Foreign	Zone /	Acc	eptable l	No.	
and Foreign	Material	Dimension	A	В	С	B
Material		D < 0.10mm	NC	NC	NC	↓
		0.10 <d 0.20mm<="" \le="" td=""><td>3</td><td>3</td><td>NC</td><td>D = (A + B)/2</td></d>	3	3	NC	D = (A + B)/2
		$0.20 < D \le 0.30$ mm	1	2	NC	5 (** 5),2
		D > 0.30 mm	0	0	NC	
		NC: No count				
		D: Mean Diameter of				

13.1.2 Line Shape and Scratches

Defect Category	Defect Description		Criteri	Drawing Specification			
Line shape	Line shape and						
and scratches	scratches	Zone /Dir	nension	Acc	Acceptable No.		
		X	Y	A	В	С	
		-	<0.01mm	NC	NC	NC	
		< 2 mm	< 0.02mm	1	1	NC	
		<1 mm	< 0.0 2mm	1	2	NC	

13.1.3 Pin Hole

Defect Category	Defect Description	Criterion	Drawing Specification
Pin Hole	Pin hole / void at light up segment	$D \le 0.20$ mm within 1 part/segment	D = (A + B)/2





13.1.4 Polarizer Bubble/Foreign Material

Defect Category	Defect Description	Crite	Drawing Specification					
	Polarizer bubble /							
	Foreign material	Zone /	Acceptable No.			<u>↑</u>		
		Dimension	A	В	С	igg $igg $		
		D ≤ 0.15mm	NC	NC	NC	← A →		
		$0.15 < D \le 0.30$ mm	3	5	NC	D = (A + B)/2		
		$0.30 < D \le 0.50$ mm	2	3	NC	D = (A + B)/2		
		$0.50 < D \le 1.0$ mm	0	1	NC			
		NC: No count						
		D: Mean Diameter of	Defect					
		loes rea						

Note: Total defects shall not exceed five

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14. Precaution for using LCM

1. Liquid Crystal Display (LCD)

LCD is made up of glass, organic sealant, organic fluid and polymer based polarizers. The following precautions should be taken when handling.

- b) Keep the temperature within the range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.
- c) Do not contact the exposed polarizer with anything harder than HB pencil lead. To clean dust off the display surface, wipe gently with cotton, chamois or other soft material soaked in petroleum benzin.
- d) Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or colour fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- e) Glass can be easily chipped or cracked from rough handling, especially at corners and edges.
- f) Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules.

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modification. The following should be noted.

- a) Do not tamper in any way with the tabs on the metal frame.
- b) Do not modify the PCB by drilling extra holes, changing its outline, moving its component or modifying its pattern.
- Do not touch the elastomer connector, especially insert a backlight panel (for example, EL)
- d) When mounting a LCM make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

a) Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

2.2 Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- a) The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- b) The modules should be kept in antistatic bags or other containers to static for storage.
- Only properly grounded soldering irons should be used.
- d) If an electric screwdriver is used, it should be well grounded and shielded from commutator spark.
- e) The normal static prevention measures should be observed for work clothes and working benches, the latter conductive (rubber) mat is recommended.
- f) Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3 Soldering

- a) Solder only to the I/O terminals.
- Use only soldering irons with proper grounding and no leakage.
- c) Soldering temperature: 280 °C
- d) Soldering time: 3 to 4 sec
- e) Use eutectic solder with resin flux fill.
- f) If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed afterwards.





2.4 Operation

- a) The contras can be adjusted by varying the LCD driving voltage V0
- b) Driving voltage should be kept within specified range, excess voltage shortens display life.
- Response time increases with decrease in temperature.
- d) Display may turn black or dark blue at temperature above its operational range, this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
- e) Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

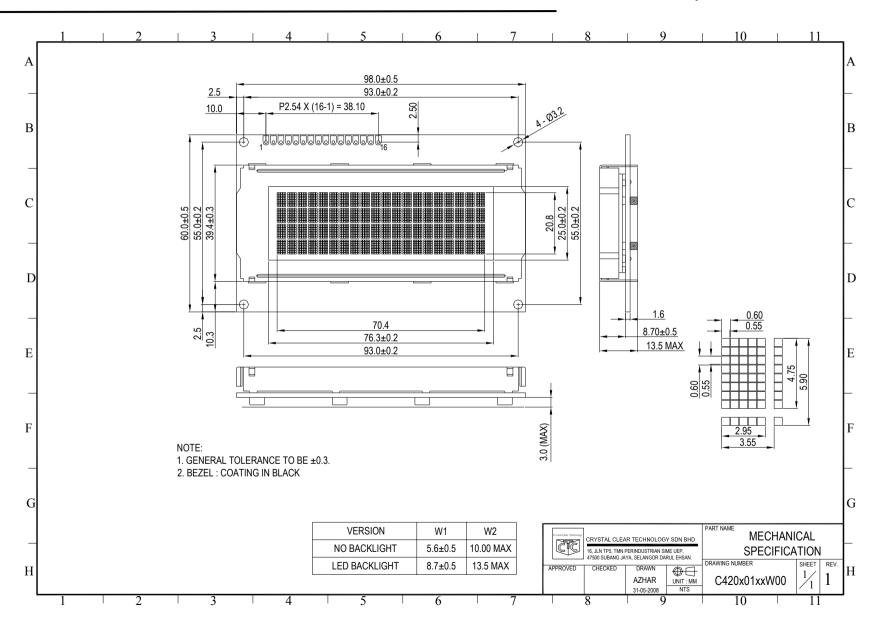
2.5 Storage

If any fluid leaks out of the damage glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6 Limited Warranty

Unless otherwise agreed between Crystal Clear Technology and customer, Crystal Clear Technology will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with Crystal Clear Technology acceptance standards, for a period of one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of Crystal Clear Technology is limited to repair and/or replacement on the terms set forth above. Crystal Clear Technology will not responsible for any subsequent or consequential events.







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